

#### **Features**

- Top view 1615 package
- Wide viewing angle
- RBG individual control
- High reliability
- RoHS compliance

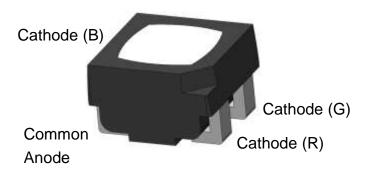
### **Applications**

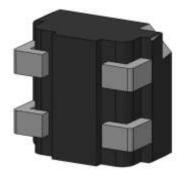
- General lighting
- Indoor signage display applications
- Switch light
- Decorative and Entertainment lighting

### **Description**

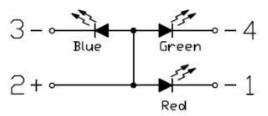
The RBGC161510-PKTC17 is a high brightness device designed for demanding applications in efficiency and reduced space. An ideal device in emphasizing visual effects, advertisement, decoration as well as general backlighting needs.

### **Package Outline**





### **Schematic**





### Absolute Maximum Rating at 25°C

Symbol	Parameters		Ratings	Units	Notes
		R	20		
lF	Continuous Forward Current	G	15	mA	
		В	15		
		R	25		
I <sub>FP</sub>	I <sub>FP</sub> Peak Forward Current		20	mA	1
			20		
VR	Reverse Voltage		5	V	
T <sub>opr</sub>	Operating Temperature		-40 ~ +85	οС	
T <sub>stg</sub>	Storage Temperature		-40 ~ +100	οС	
T <sub>sol</sub>	Soldering Temperature		260	οС	2
	Device Discipation of the bolow 25°C Free Air	R	40		
P <sub>D</sub>	Power Dissipation at(or below) 25°C Free Air	G	50	mW	
	Temperature	В	50		

### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

### **Optical Characteristics (Red)**

	, ,						
Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =8mA	46	-	78	mcd	3
λd	Dominant Wavelength	I <sub>F</sub> =8mA		624.5	-	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =5mA	-	±60	-	deg	

### **Electrical Characteristics (Red)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
$V_{F}$	Forward Voltage	I <sub>F</sub> =8mA	1.6	-	2.4	٧	5
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =10V	-	-	1	μA	



### **Optical Characteristics (Green)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =5mA	102	-	172	mcd	3
λd	Dominant Wavelength	I <sub>F</sub> =5mA	-	525.5	-	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =5mA	-	±60	-	deg	

#### **Electrical Characteristics (Green)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =5mA	2.4	-	3.4	V	5
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =10V	-	-	1	μA	

### **Optical Characteristics (Blue)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =3mA	20	-	34	mcd	3
λd	Dominant Wavelength	I <sub>F</sub> =3mA	-	468.0	-	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =10mA	-	±60	-	deg	

### **Electrical Characteristics (Blue)**

Symbol	Symbol Parameters Test Conditions Min Typ Max Unit		Units	Notes			
VF	Forward Voltage	I <sub>F</sub> =5mA	2.4	-	3.4	V	5
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =10V	-	-	1	μΑ	

#### Notes:

- 1. I<sub>FP</sub> Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time ≤ 10 seconds.
- 3. Bin Range of Luminous Intensity

		Red		
Bin Code	Min	Max	Unit	Condition
D1	46	60	mad	I <sub>F</sub> =8mA
E1	60	78	mcd	IF=0IIIA
		Green		
Bin Code	Min	Max	Unit	Condition
J1	102	132	mad	I_ 5m Λ
K1	132	172	mcd	I <sub>F</sub> =5mA



		Blue		
Bin Code	Min	Max	Unit	Condition
Z1	20	26	mad	I- 2m Λ
A1	26	34	mcd	I₅=3mA

Tolerance of Luminous Intensity ±10%.

#### 4. Bin Range of Dominant Wavelength

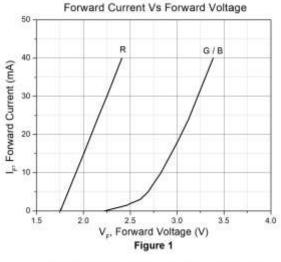
		Red				
Bin Code	Min	Max	Unit	Condition		
R1	619.5	624.5		I_ Ωm Λ		
R2	624.5	629.5	nm	I⊧=8mA		
	Green					
Bin Code	Min	Max	Unit	Condition		
G1	521.0	525.0		I- Em A		
G2	525.0	529.0	nm	I <sub>F</sub> =5mA		
		Blue				
Bin Code	Min	Max	Unit	Condition		
B1	464.0	468.0	nm	I2m Λ		
B2	468.0	472.0	nm	I <sub>F</sub> =3mA		

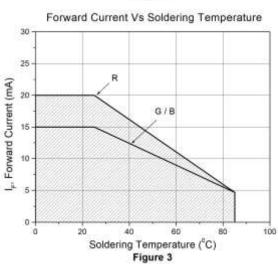
Tolerance of Dominant Wavelength: ±1nm.

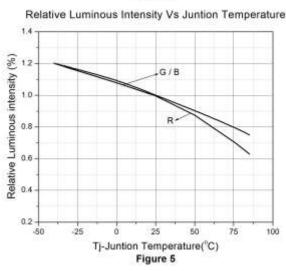
5. Tolerance of Forward Voltage: ±0.1V.

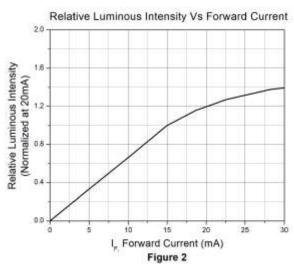


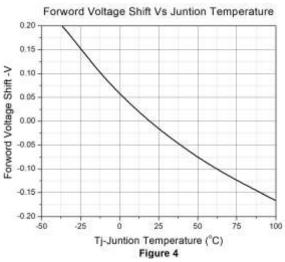
### **Typical Characteristic Curves**

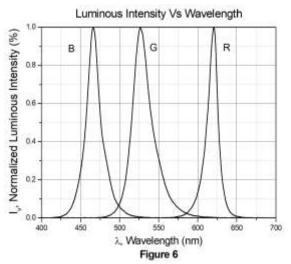






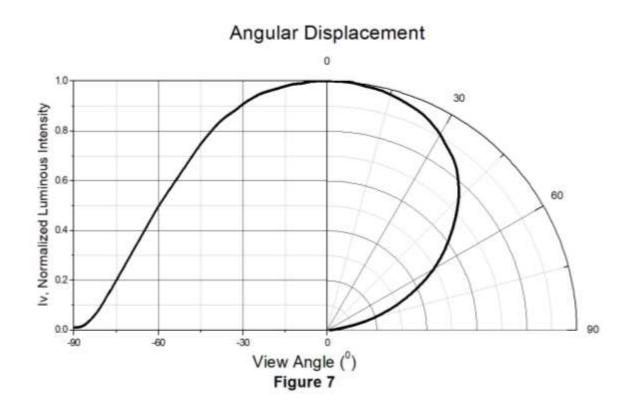






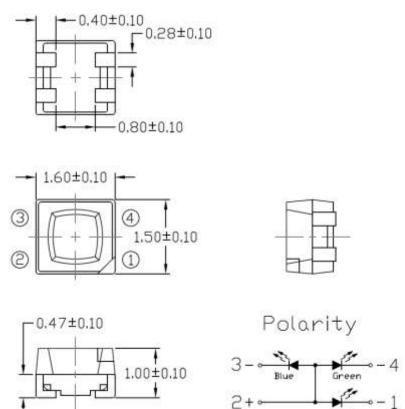


### **Typical Characteristic Curves**



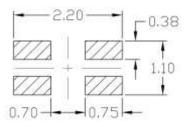


### Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm

### Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



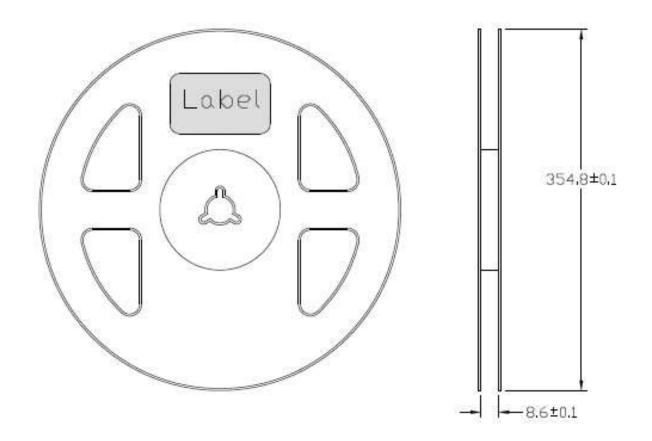
Note: Tolerance unless mentioned is ±0.1mm

### **Ordering Information**

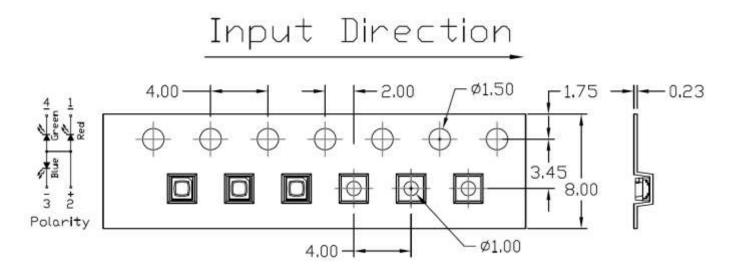
Part Number	Description	Quantity
RBGC161510-PKTC17	Tape & Reel	17000 pcs



#### Reel Dimension All dimensions are in mm, unless otherwise stated



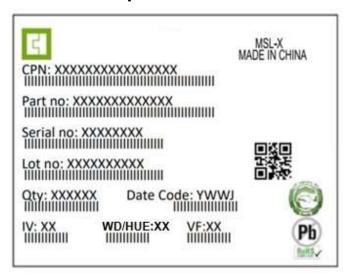
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm



### **Label Form Specification**



CPN : Customer Part Number

Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV : Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

HUE: Bin Code of Chromaticity Coordinates

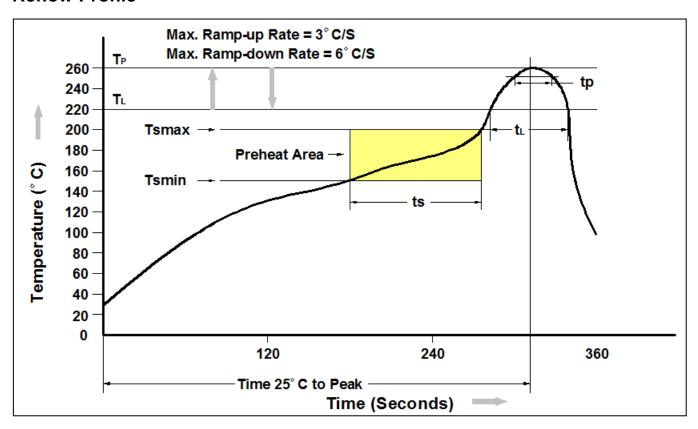
VF : Bin Code of Forward Voltage MADE IN CHINA: Production Place

### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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